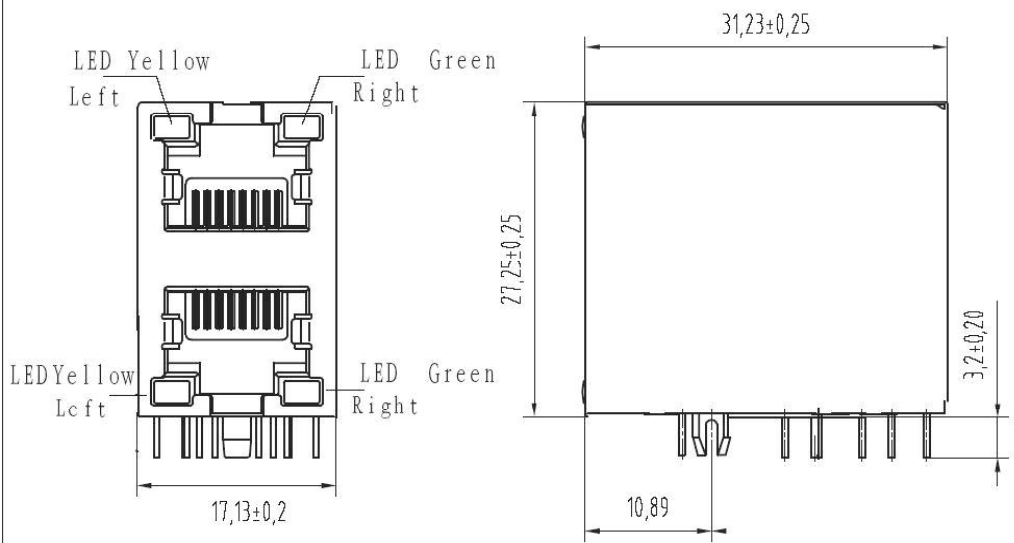


REVISION RECORD				
REV	ECD	DESCRIPTION	DRFT	CHKD



NOTES:

MATERIAL:

- 1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
- 2. CONTACT MATERIAL : PHOSPHOR BRONZE t=0.35mm.
- 3. PLATING : GOLD PLATING 3u"~50u" OVER NICKEL.

ELECTRICAL:

- 1. VOLTAGE RATING : 125 VAC RMS.
- 2. CURRENT RATING : 1.5 AMP.
- 3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
- 4. INSULATION RESISTANCE : 500 MEGOHMS MIN @ 500V DC .
- 5. DIELECTRIC WITHSTANDING RESISTANCE : 1000V AC RMS 50Hz. 1MIN.

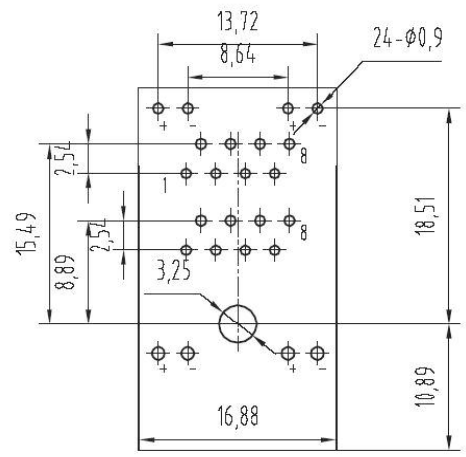
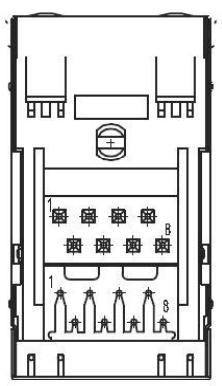
MECHANICAL:

- 1. DURRABILITY: : 750 CYCLES MIN.
- 2. PCB RETENTION PRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL:

- 1. STORAGE : -40° C TO 85° C.
- 2. OPERATION : 0° C TO 70° C.

PART NUMBER:



PC Board Layout
Component Side Shown

DETACHED LISTS	MM (INCH)		DFTO: SHB	DATE: 2007.05.05	HO CHIEH <i>www.hochien.com</i>	
	TOLERANCES EXCEPT AS NOTED		CHKD: LANBO	DATE: 2007.05.05		
	MM	±	APPVL:	DATE:	TITLE 5921-8P8C-LED	
	.0 ± 0.15	±	MATERIAL :			
.00 ± 0.075	±	QT'Y :		DRAWING NO. TE52A1003	SIZE	REV
.000 ± 0.05	±	FINISH :		/PART NO.	A3	0
ANGLES ± 0.5		SCALE :		DO NOT SCALE DRAWING	SHEET	OF